

1

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A

B

C

D

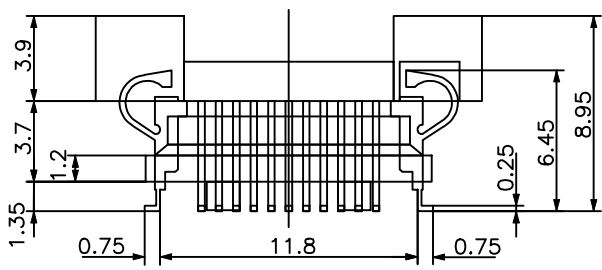
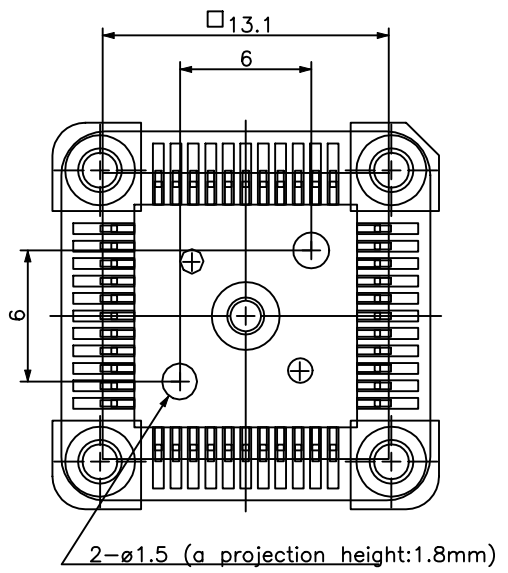
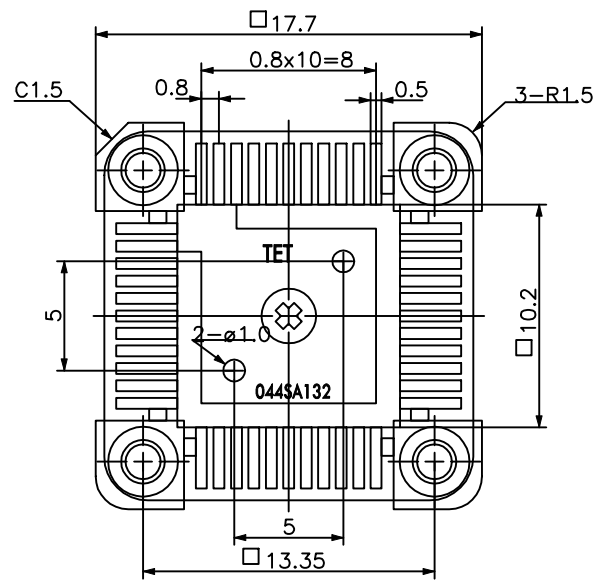
A

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REVISIONS				
ZONE	REV	DESCRIPTION	DATE	APPROVED

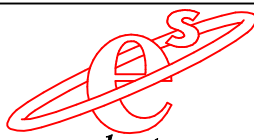


\* Applicable size of IC package : IC body size 10.0 x 10.0 mm  
IC outer size 13.2 x 13.2 mm

IC package	Square
Pin count	44Pin
Lead pitch	0.8mm

**DRAWING NOT TO SCALE**

**ALL DIMENSIONS ARE IN MILLIMETERS**

 <a href="http://www.adapters.com">www.adapters.com</a>	<b>adapters.com</b> <i>An Embedded Systems Solutions Company</i>		
	DESCRIPTION: BASE-NQ-044Q8-SMT(13.2)		
TEL:(408)855-8527 FAX:(408)855-8528 3024 Scott Blvd. Santa Clara, CA 95054	SIZE <b>A</b>	DATE: 12-10-01	PART NO. <b>000-2066-05</b>
SCALE 1:1	CHECKED: Gabor Kardos	DRAWN BY: S. Barcellos	REV SHEET

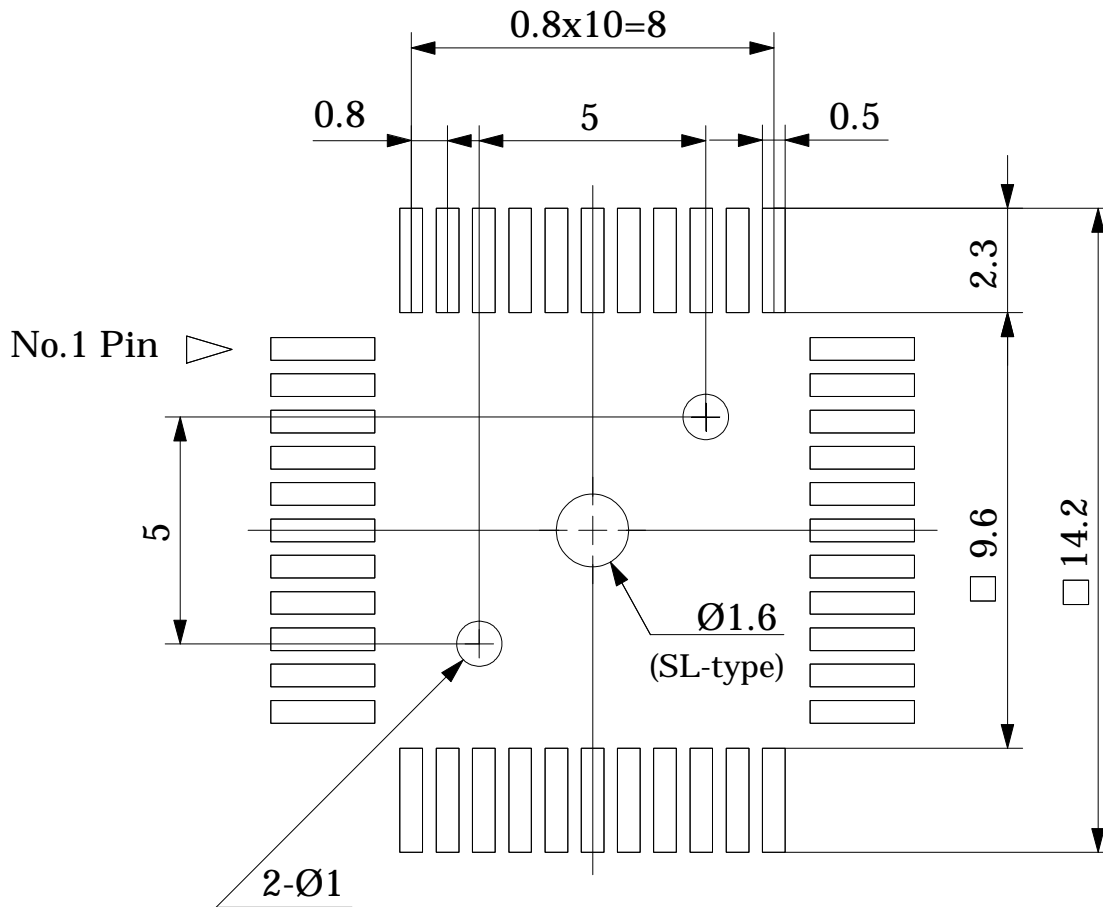
1

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## Recommended a Footpateron of NQPACK044SA132



\* Recommended foot pattern shown on left is for NQPACK soldering.  
 But please refer to IC package foot pattern recommended by IC manufacturer  
 also, when the package is soldered on the same foot pattern.

Part No.	<b>NQPACK044SA132</b>	
IC package	Square	
Pin count	44Pin	
Lead pitch	0.8mm	
Unit : mm	Design : M.H	
<b>TET</b> TOKYO ELETECH CORP.		